

FORM PTO-1595

(Rev. 08/05)

01-08-2007



103357460

U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

DUCKET 110.: 002007 0377	OTIE	
To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.		
1. Name of Conveying Party(ies)	2. Name and address of receiving party(ies)	
Akiyuki SUGIYAMA, Hiroyuki SHINDO	Name: HITACHI HIGH-TECHNOLOGIES	
1 - 3-0 /	CORPORATION	
Additional name(s) of conveying party(ies) attached? Yes No	Address: 24-14, Nishishinbashi 1-chome,	
3. Nature of Conveyance/Execution Date(s)	Minato-ku,	
Execution Date(s): December 19, 2006	Tokyo, JAPAN	
☐ Assignment ☐ Merger		
☐ Security Agreement ☐ Change of Name		
☐ Joint Research Agreement		
Government Interest Assignment		
Executive Order 9424, Confrmatory License		
Other	Additional name(s) & address(es) attached? Yes No	
4. Application or patent number(s):	This document is being filed together with a new application.	
A. Patent Application No(s).	B. Patent No(s).	
11/520,800 filed on September 14, 2006		
Additional numbers attack		
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents 1 involved:	
Name: MCDERMOTT WILL & EMERY LLP		
Internal Address:		
internal Address.	Authorized to be charged by credit card	
Street Address: 600 13th Street, N.W.	Authorized to be charged to deposit account Enclosed	
Street Address. 000 15th Street, IV. W.	☐ None required (government interest not affecting title)nt	
City: Washington State: D. C. Zip: 20005-3096	None required (government interest not affecting title) it	
Phone Number: 202.756.8000	9 Daymont Information	
Fax Number: 202.756.8087	8. Payment Information:	
Email Address:	· · · · · · · · · · · · · · · · · · ·	
Eman Address.	d. Ordan card East 4 Manbers	
	b. Deposit Account Number 500417	
	Authorized User Name	
0.00	2 4 d	
9. Signature.	January 3, 2007	
Keith E. George, Registration No. 34,111	January 3, 2007	
5 5	Signature g cover sheet, attachments and documents: 2	
Total number of pages including cover sheet, attachments and documents:		
OMB No. 0651-0027 (exp. 6/30/2008)	92 93 25 25	
	01/05/2007 01 FC: 8021	

PATENT REEL: 018747 FRAME: 0665

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SYSTEM AND METHOD OF IMAGE PROCESSING, AND SCANNING ELECTRON MICROSCOPE

XU.S. application number 11/520800 filed on September 14, 2006 invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside signatures:

RECORDED: 01/03/2007

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	ahiyuhi Lugiyama	11 / 19 / 2006
2)	Akiyuhi Sugiyama Akiyuki SUGIYAMA Huoyuki Shhudo	11/19/2006
3)	Hiroyuki SHINDO	
4)		
5)		
6)		
7)		
8)		
9)		
10)		

PATENT REEL: 018747 FRAME: 0666